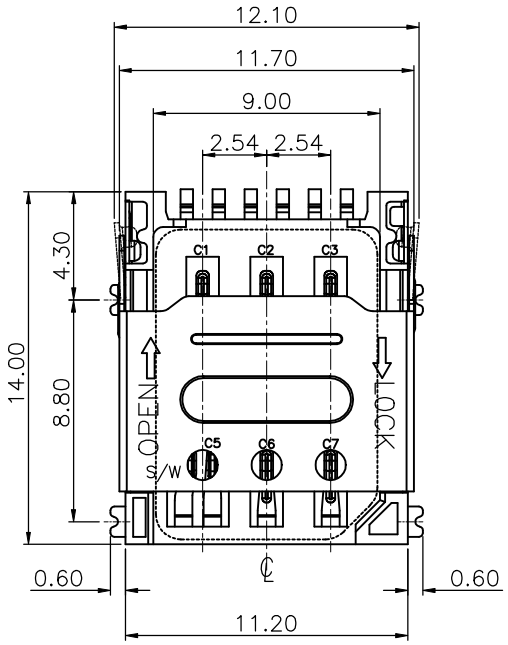
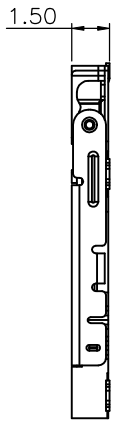
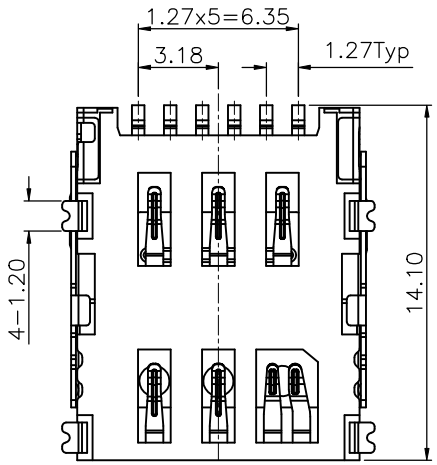
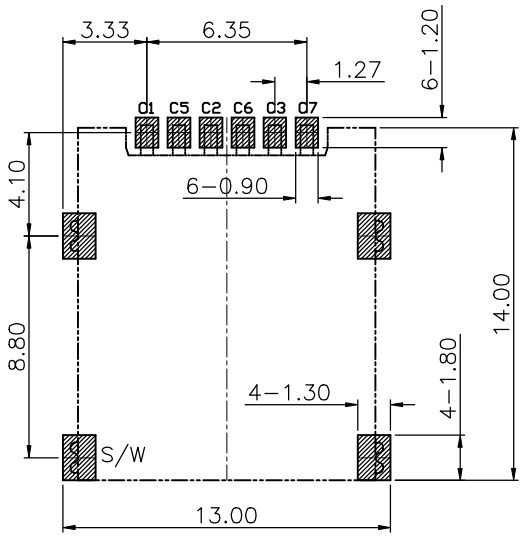
Rev No.	Description of Revision	Date	Name	Approved	ECN No.
X					





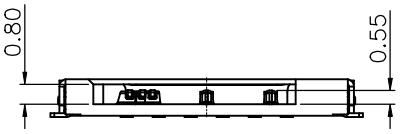


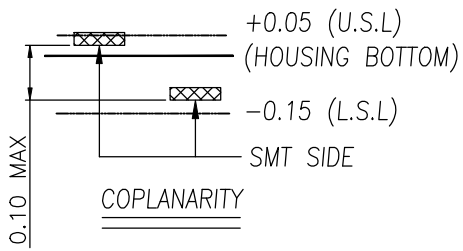


RECOMMENDED PCB LAYOUT

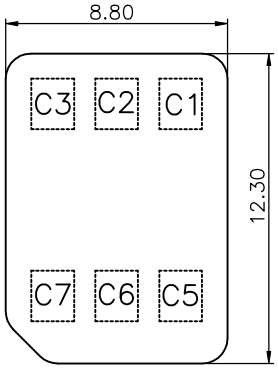
GENERAY TOLERANCE ±0.05

SMT SOLDER AREA





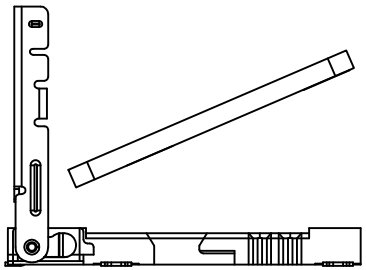
COPLANARITY



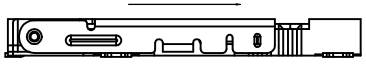
NANO SIM CARD

NOTES:

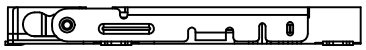
1. ELECTRICAL CHARACTERISTICS
   - 1-1. CONTACT RESISTANCE: 60 Milliohms Max
   - 1-2. INSULATION RESISTANCE: 1,000 Megohms Min.
   - 1-3. VOLTAGE RATING: 50V.
   - 1-4. CURRENT RATING: 1.0A.
2. MECHANICAL CHARACTERISTICS
   - 2-1. OPERATION TEMPERATURE RANGE: -20°C~+85°C
   - 2-2. DURABILITY: 5000 CYCLES
3. MATERIAL:
   - 3-1. HOUSING: THERMOPLASTIC,UL 94-V0
   - 3-2. TERMINAL: PHOSPHOR BRONZE,T=0.15
   - 3-3. SHELL: STAINLESS STEEL,T=0.20
4. FINISHED:
   - 4-1. TERMINAL: Ni PLATED UNDER, 3U" Au MIN PLATED ON CONTACT AREA,AU PLATED ON SOLDER TAIL



STEP 1 INSERT Micro-SIM CARD

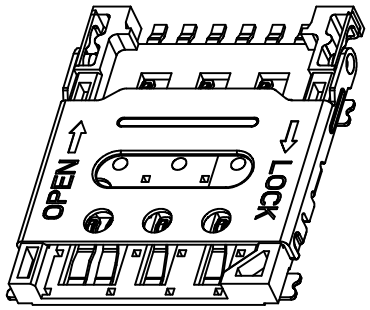


STEP 2 PUSH THE SHELL



STEP 3 FINISH

NANO SIM CARD	
Pin No.	NAME
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O
S/W	Switch Pin



UNLESS OTHERWSE SPECIFED TOLERANCES		广东国连电子有限公司 GUANGDONG GUOLIAN ELECTRONICS CO.,LTD			
DECIMALS:	ANGLES	TITLE. NANO SIM 1.50H 带检测PIN 掀盖式卡座			
X. ±0.20	X°. ±2°	Drawn. JACK	PART NO. NNB5FW1072E3		
X.X ±0.15	X.X° ±1°	Checked. LEE	SCALE. 3:10	UNIT. mm	PROJ.
X.XX ±0.10	X.XX° ±0.5°	Approved. LEE	SIZE. A4	SHEET. 1 OF 1	REV. A
X.XXX ±0.05		CUSTOMER COPY			